

**ON Semiconductor®** 

# FDS6673BZ-F085 P-Channel PowerTrench<sup>®</sup> MOSFET -30V, -14.5A, 7.8mΩ

### **General Description**

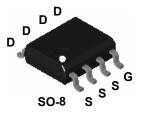
This P-Channel MOSFET is produced using ON Semiconductor's advanced Power Trench process that has been especially tailored to minimize the on-state resistance.

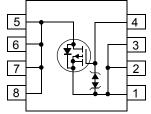
This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.



#### Features

- Max  $r_{DS(on)} = 7.8 m\Omega$ ,  $V_{GS} = -10V$ ,  $I_D = -14.5A$
- Max  $r_{DS(on)} = 12m\Omega$ ,  $V_{GS} = -4.5V$ ,  $I_D = -12A$
- Extended V<sub>GS</sub> range (-25V) for battery applications
- HBM ESD protection level of 6.5kV typical (note 3)
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- DS(on)
  High power and current handling capability
- RoHS compliant
- Qualified to AEC Q101





#### **MOSFET Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		-30	V
V <sub>GS</sub>	Gate to Source Voltage		±25	V
I <sub>D</sub>	Drain Current -Continuous (N	ote1a)	-14.5	Α
	-Pulsed		-75	Α
P <sub>D</sub>	Power Dissipation for Single Operation (N	lote1a)	2.5	
	1)	lote1b)	1.2	W
	1)	lote1c)	1.0	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 150	°C

### **Thermal Characteristics**

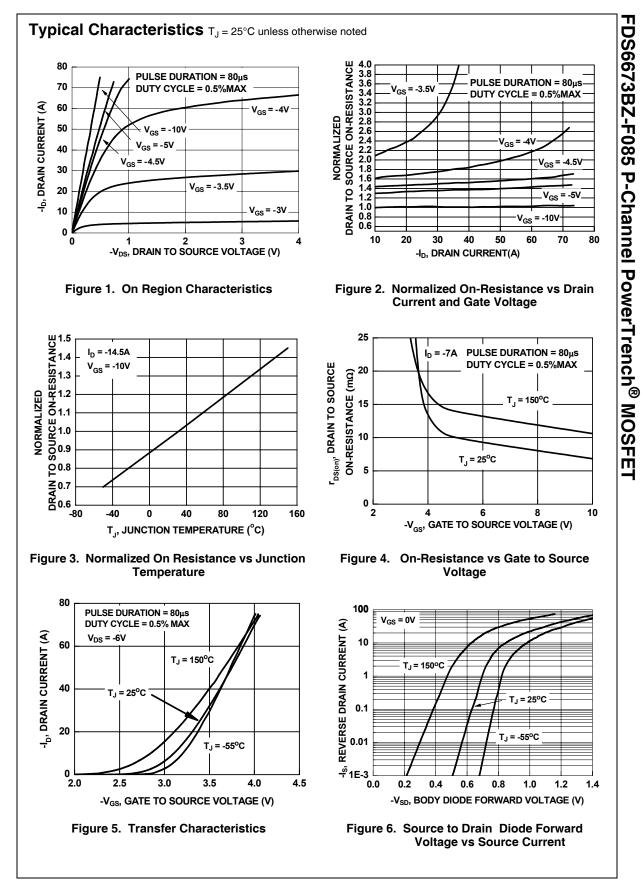
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case (Note 1)	25	°C/W

## Package Marking and Ordering Information

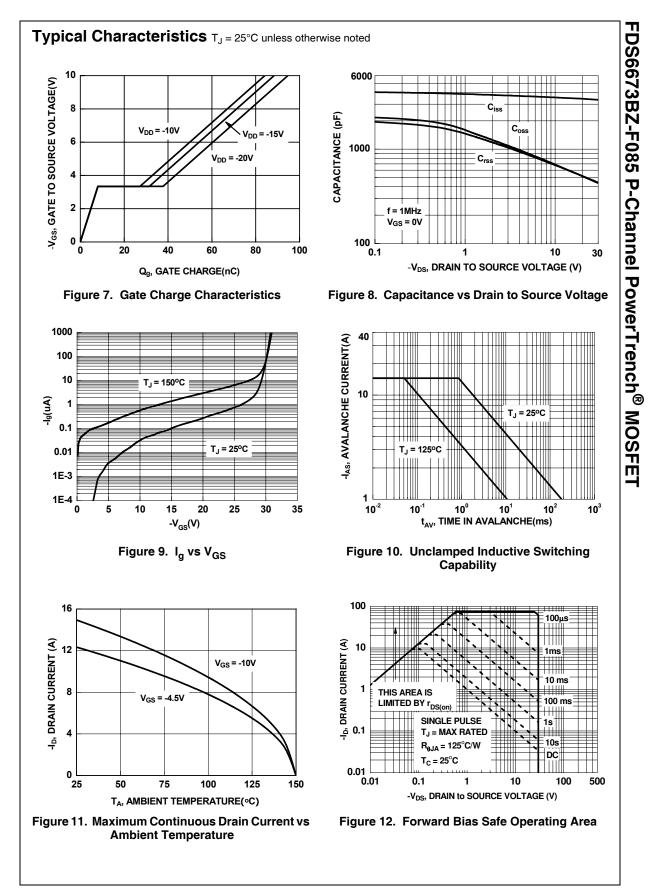
Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6673BZ	FDS6673BZ-F085	13"	12mm	2500 units

	Parameter	Test Conditions	Min	Тур	Max	Units
B <sub>VDSS</sub>	cteristics					
AB <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V	-30			V
$\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$ , referenced to $25^{\circ}C$		-20		mV/°C
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -24V, V <sub>GS</sub> = 0V			-1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 25V, V_{DS} = 0V$			±10	μA
	cteristics (Note 2)					
	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-1.9	-3	V
V <sub>GS(th)</sub> ∆V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$I_D = -250\mu A$ , referenced to	-1	-1.5	-0	v
$\Delta T_J$	Temperature Coefficient	25°C		8.1		mV/°C
	Drain to Source On Resistance	V <sub>GS</sub> = -10V , I <sub>D</sub> = -14.5A		6.5	7.8	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -12A		9.6	12	
r <sub>DS(on)</sub>		$V_{GS} = -10V, I_D = -14.5A$ $T_J = 125^{\circ}C$		9.7	12	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -5V, I <sub>D</sub> = -14.5A		60		S
Jynamic (	Characteristics		-	r.		
C <sub>iss</sub>	Input Capacitance			3500	4700	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V,		600	800	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0MHz		600	900	pF
Switching	Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time			14	26	ns
t <sub>r</sub>	Rise Time	$V_{DD} = -15V$ , $I_D = -1A$ $V_{GS} = -10V$ , $R_{GS} = 6Ω$		16	29	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			225	306	ns
t <sub>f</sub>	Fall Time			105	167	ns
Qg	Total Gate Charge	$V_{DS} = -15V, V_{GS} = -10V,$ $I_{D} = -14.5A$		88	124	nC
Qg	Total Gate Charge	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -5V,		46	65	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	$I_{\rm D} = -14.5 {\rm A}$		8		nC
Q <sub>gd</sub>	Gate to Drain Charge			23.5		nC
<b>Drain-Sou</b>	rce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltag	e V <sub>GS</sub> = 0V, I <sub>S</sub> = -2.1A		-0.7	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 14.5A$ , di/dt = 100A/µs			45	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_F = 14.5A$ , di/dt = 100A/µs			34	nC

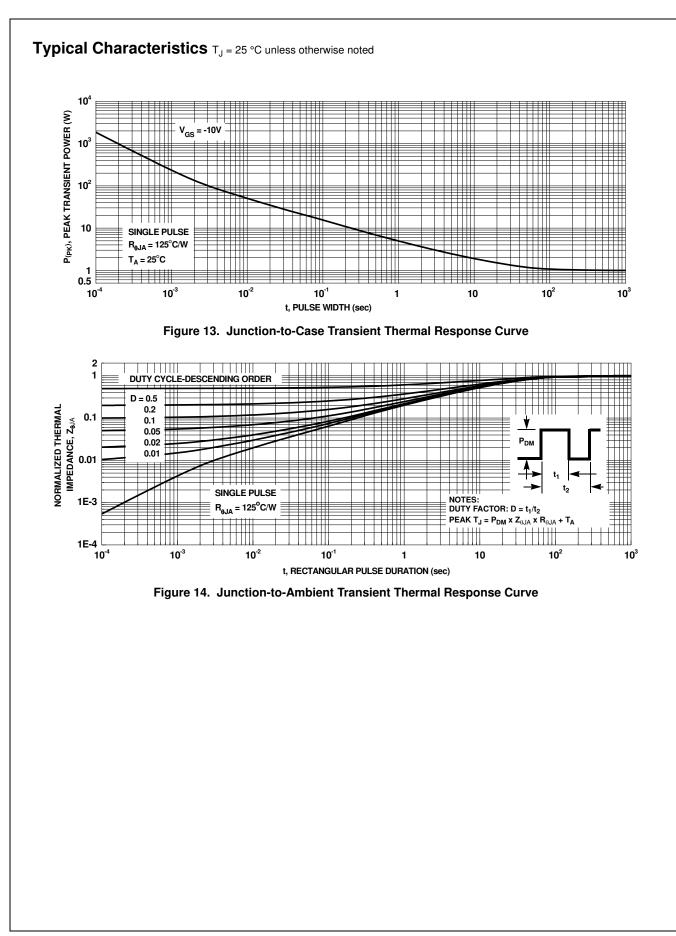
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